Abstract: This application note explains how to interface the DS34S132, a 32-point TDM-over-packet IC, with a DDR3 memory chip. The DS34S132 uses an external double data rate (DDR) synchronous DRAM (or DDR1) device to buffer data. The memory supplies sufficient buffer space to support a 256ms Packet-Delay Variation (PDV) for each of the 256 pseudowires (PWs)/bundles and to enable packet reordering.

Introduction

The DS34S132, a 32-port TDM-over-packet IC, uses an external double data rate (DDR) synchronous DRAM (also referred to as "DDR1") device to buffer data. The large memory supplies sufficient buffer space to support a 256ms Packet-Delay Variation (PDV) for each of the 256 individually configurable pseudowires (PWs)/bundles. The memory also enables packet reordering if the packet switch network (PSN) incorrectly arranges the packets. Since DDR3 is readily available, it is more convenient to use a DDR type 3 (DDR3) memory chip with the DS34S132. This application note explains how to interface the DS34S132 with a DDR3 memory chip.

Figure 1 shows the proposed block diagram to replace DDR1 with a FPGA and DDR3.

Figure 1. Replacing DDR1 with DDR3 and FPGA.

The DDR SDRAM interface has higher transfer rates than a typical SDRAM, due to its sophisticated timing control of electrical data and clock signals. For example, a DDR SDRAM with a 125MHz clock frequency can achieve almost twice the bandwidth (BW) of a SDRAM running at the same frequency. Thus, Maxim now uses DDR1 instead of SDRAM, which was used in the previous generation of Maxim's TDM over Packet (TDMoP) devices.

DDR3 SDRAM is a DRAM-interface specification. The actual DRAM arrays that store the data are similar to earlier types, with similar performance. DDR3 SDRAM can transfer data at four times the rate of DDR1, and thus enables higher bandwidth.

These days, DDR1 memory modules are not as widely available as DDR2 or DDR3. Unfortunately, DDR2 and DDR3 are neither backward- nor forward-compatible with DDR1. Thus, DDR2 or DDR3 memory modules will not work in DDR-equipped motherboards, and vice versa.

DDR Interface Configuration of the DS34S132

Inside the DS34S132 TDMoP device,

- The DDR1 interface must be programmed to a column-address-strobe (CAS) latency of 3.
- The "refresh rate" must be calculated and programmed to have a fast-enough interval for the DDR3 memory module.
- The clock rate for the DDR is 125MHz.
It is worth noting that DDR3 has 8 banks. The DS34S132 has only 2 bank select bits. Hence one half of the DDR3 memory module (upper banks) will be unused.

Configuration of the DDR3

DDR3 should run at a clock speed of 500MHz. This frequency is chosen since it is four times the DDR1 clock speed of 125MHz.

For the Verilog® RTL simulation, we used 8-bit data, which will have a BW of 500MHz × 2 × 8 bits. This BW is twice the BW of 125MHz × 2 × 16 bits on the DDR side. The extra BW will be used to pipeline and pass back the read data from DDR3 to the DS34S132 without use of FPGA FIFO memory. For the DDR3, we used:

- CAS latency: 8
- CAS write latency: 6
- DLL reset, then enabled.

The Micron DDR3 MT41J128M8 (16 Meg × 8 × 8 banks) specifications were used for simulation. The cycle time for the DDR3 was 1.87ns at CL = 8 (DDR3 - 1066) -187. Support for other DDR3 configurations/speed may require incremental or significant effort. The DDR3 that we used for simulation had the following specifications:

FPGA Configuration

The FPGA has critical functions:

- At power-up, it initializes the DDR3 memory chip.
- Once initialization is complete, it services the following incoming DDR1 commands from the DS34S132 by converting to DDR3 commands/data.
  
  i. Read
  ii. Write
iii. Precharge
iv. Use a digital clock module (DCM) to multiply the incoming DDR1 clock (125MHz) from the DS34S132 by 4 to generate the DDR3 clock (500MHz).
v. Use a second DCM to generate four phases of the DDR3 clock for edge timing to the DDR3. Additionally, a feedback clock (out and back of an IO pad) will optimally adjust the phase relationship of these clocks to the DDR1 clock edge. This would help read data timing back to the DS34S132.

Next, the FPGA and the DDR3 memory combined will appear like a DDR1 memory for the DS34S132. The FPGA code includes DCMs and IO DDR primitives. Please download these codes and the specifications from this link here.

The FPGA used is Spartan for Verilog RTL simulation has a speed grade of -4, which should be capable of 500MHz. FPGA resources use approximately 300 flip flops with no FPGA RAM being used. We also used two DCMs to convert clock rates. To verify the operation of the DDR1-to-DDR3 conversion scheme, we ran the following tests in Verilog RTL simulations:
- Run test in DDR1 mode and log results.
- Run test in DDR3 mode via FPGA and log results.
- Monitor some DDR3 writes and read individually verified using monitor against DDR1 writes and read. Figure 2 and Figure 3 show the write and read simulation results of DDR1 and DDR3.

In this Verilog RTL simulation, we could successfully send the signal from DDR3 through FPGA to the device effectively. We also successfully read the signal from the device to DDR3. Thus, the simulation result proved that this conversion scheme from DDR1 to DDR3 test operates correctly.

Figure 2. The write simulation results of DDR1 (top) and DDR3 (bottom).
Conclusion

We implemented a Verilog RTL simulation of FPGA with the Micron DDR3 MT41J128M8 parameter model and are confident that it will work with the DDR3 and the Spartan FPGA. However, this solution will not be successful for all DDR3s, and knowing which DDR3 to implement is the designer's responsibility. FPGA mapping was not implemented and bit file was not used.

For further information on TDMoP devices or other Maxim telecom products, please visit our contact the Communication and Timing Products applications support team.

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<table>
<thead>
<tr>
<th>Related Parts</th>
<th>Free Samples</th>
</tr>
</thead>
<tbody>
<tr>
<td>DS34S132</td>
<td>32-Port TDM-over-Packet IC</td>
</tr>
</tbody>
</table>

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